mail

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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





0.010 (0.26)

0.002 (0.06)

NOTE:

SOLID STATE LED LAMPS SUBMINIATURE T-1 3/4 (1.9mm)

PACKAGE DIMENSIONS 0.087 (2.2) 0.079 (2.0) EMITTER 0.276 (7.0) MIN 0.024 (0.6) . 0.016 (0.4) ANODE 0.091 (2.3) 0.083 (2.1) ł 0.020 (0.5) 0.012 (0.3) 0.075 (1.9) 0.063 (1.6) 0.058 (1.40) 0.050 (1.28) 0.056 (1.44) 0.048 (1.24)

CATHODE MARK

Dimensions are in inches (mm).

(COLOR STRIPE ON SIDE OF PACKAGE)

0.031 (0.78)

0.023 (0.58)

AlGaAs RED	HLMP-Q106A	Clear
AllnGaP ORANGE	HLMA-QH00A	Clear
AllnGaP YELLOW	HLMA-QL00A	Clear

FEATURES

- Subminiature package
- Low profile package
- Three lead bend options for surface mounting
- Available in tape and reel



DESCRIPTION

These subminiature LED lamps are intended for high volume, low cost status indication on PCBs, as well as for backlighting keyboards and switches. Choices of "Yoke", "Z-Bend" or "Gull-Wing" lead bends are available.

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)						
Parameter	AlGaAs Red HLMP-Q106A	AllnGaP Orange HLMA-QH00A	AlinGaP Yellow HLMA-QL00A	Units		
Continuous Forward Current - I _F	50	50	50	mA		
Peak Forward Current - I _F	200	100	100	mΔ		
(f = 1.0 KHz, Duty Factor = 1/10)	200	100	100	ША		
Reverse Voltage - $V_R (I_R = 10 \ \mu A)$	5	5	5	V		
Power Dissipation - P _D	100	120	120	mW		
Operating Temperature - T _{OPR}	-40 to +100			°C		
Storage Temperature - T _{STG}	-40 to +100			°C		
Lead Soldering Time - T _{SOL}						
Wave	260 for 5 sec			°C		
Reflow	260 for 10 sec					

ELECTRICAL / OPTICAL CHARACTERISTICS (TA =25°C)

Part Number	AlGaAs Red HLMP-Q106A	AllnGaP Orange HLMA-QH00A	AllnGaP Yellow HLMA-QL00A	Condition
Luminous Intensity (mcd)				$I_F = 20 \text{mA}$
Minimum	50	150	150	
Typical	500	500	500	
Forward Voltage (V)				$I_F = 20 \text{mA}$
Maximum	2.4	2.4	2.4	
Typical	1.9	1.9	1.9	
Peak Wavelength (nm)	660	620	590	$I_F = 20 \text{mA}$
Spectral Line Half Width (nm)	20	18	15	I _F = 20mA
Viewing Angle (°)	25	25	25	$I_F = 20 mA$



SOLID STATE LED LAMPS SUBMINIATURE T-1 3/4 (1.9mm)

AIGaAs REDHLMP-Q106AClearAlInGaP ORANGEHLMA-QH00AClearAlInGaP YELLOWHLMA-QL00AClear

TYPICAL PERFORMANCE CURVES





Fig. 3 Relative Intensity vs. Peak Wavelength Fig. 4

Fig. 4 Relative Luminous Intensity vs. Angular Displacement



SOLID STATE LED LAMPS SUBMINIATURE T-1 3/4 (1.9mm)

AlGaAs RED	HLMP-Q106A	Clear
AllnGaP ORANGE	HLMA-QH00A	Clear
AllnGaP YELLOW	HLMA-QL00A	Clear



0.120 (3.04)

0.244 (6.20) 0.236 (6.00)



NOTE All dimensions are in inches (millimeters)

www.qtopto.com

Call QT Optoelectronics for more information or the phone number of your nearest distributor.

0.027 (0.68)

United States 800-533-6786 • France 33 [0] 1.45.18.78.78 • Germany 49 [0] 89/96.30.51 • United Kingdom 44 [0] 1296 394499 • Asia/Pacific 603-7352417



SOLID STATE LED LAMPS SUBMINIATURE T-1 3/4 (1.9mm)

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